

Notification Number:	20160304000	Notification Date:	03/14/2016
Title:	Datasheet update for BQ29200/BQ29209/BQ29209-Q1		
Customer Contact:	PCN Manager	Dept:	Quality Services
Change Type:			
<input type="checkbox"/>	Assembly Site	<input type="checkbox"/>	Design
<input type="checkbox"/>	Assembly Process	<input checked="" type="checkbox"/>	Data Sheet
<input type="checkbox"/>	Assembly Materials	<input type="checkbox"/>	Part number change
<input type="checkbox"/>	Mechanical Specification	<input type="checkbox"/>	Test Site
<input type="checkbox"/>	Packing/Shipping/Labeling	<input type="checkbox"/>	Test Process
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Site
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Material
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Process
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Site
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Materials
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Process

Notification Details

Description of Change:

Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as seen in the change revision history below:



bq29200, bq29209

SLUSA52C – SEPTEMBER 2010 – REVISED MARCH 2016

www.ti.com

Changes from Revision B (December 2014) to Revision C	Page
• Changed <i>Typical Application</i> title to <i>Simplified Schematic</i>	1
• Changed resistor R _{VD} location, added PACK+ and PACK- in the <i>Simplified Schematic</i> image	1
• Deleted the Lead Temperature (soldering) from the <i>Absolute Maximum Ratings</i> table	4
• Deleted table notes 2 through 7 from the <i>Thermal Information</i>	5
• Changed resistor R _{VD} location in Figure 9	13
• Added title to Table 1	13
• Changed resistor R _{VD} location, added PACK+ and PACK- in Figure 11	14



bq29209-Q1

SLUSC62A – JUNE 2015 – REVISED MARCH 2016

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Changes from Original (June 2015) to Revision A	Page
• Changed resistor R _{VD} location, added PACK+ and PACK- in the <i>Simplified Schematic</i> image	1
• Deleted the Lead Temperature (soldering) from the <i>Absolute Maximum Ratings</i> table	3
• Changed resistor R _{VD} location in Figure 9	12
• Added title to Table 1	12
• Changed resistor R _{VD} location, added PACK+ and PACK- in Figure 11	13

The datasheet number will be changing.

Device Family	Change From:	Change To:
BQ29200/BQ29209 BQ29209-Q1	SLUSA52B SLUSC62	SLUSA52C SLUSC62A

These changes may be reviewed at the datasheet links provided.

<http://www.ti.com/product/bq29200>

<http://www.ti.com/product/bq29209-q1>

Reason for Change:

To more accurately reflect device characteristics.

Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

No anticipated impact. This is a specification change announcement only. There are no changes to the actual device

Changes to product identification resulting from this notification:

None.			
Product Affected:			
BQ29200DRBR	BQ29209DRBR	BQ29209QDRBRQ1	BQ29209TDRBTQ1
BQ29200DRBT	BQ29209DRBT	BQ29209TDRBRQ1	

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
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